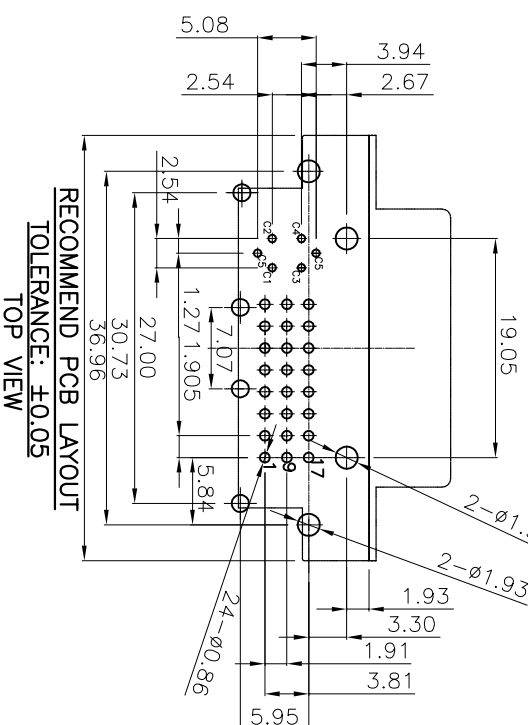
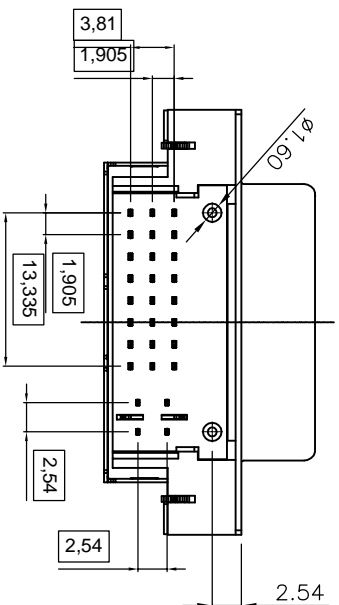


1. HOUSING: THERMOPLASTIC (UL 94V-0).
 2. COVER: THERMOPLASTIC (UL 94V-0).
 3. TERMINAL: COPPER ALLOY,
GOLD PLATED ON CONTACT AREA,
TIN PLATED ON SOLDER TAILS,
NICKEL UNDER PLATED OVERALL.
 4. BOARD LOCK: SPCC, TIN PLATED OVER NICKEL.
 5. SHELL: SPCC, NICKEL PLATED OVERALL.
 6. RIVET: Zn ALLOY, NICKEL PLATED OVERALL.
1. MATING FORCE: 4.5KG/MAX.
 2. UNMATING FORCE: 1.0-4.0KG.
 3. DIELECTRIC WITHSTANDING VOLTAGE:
500V AC R.M.S. FOR ONE MINUTE.
 4. INSULATION RESISTANCE:
1000MΩ MIN AT 500V DC.
 5. CONTACT RESISTANCE: 30mΩ MAX.
 6. OPERATING TEMPERATURE : -25°C TO +85°C.



RECOMMEND PCB LAYOUT
TOLERANCE: ±0.05
TOP VIEW

REV	ECN NO	DESCRIPTION	DATE
A	JIONS-DVI-0004		2011/02/01

Jions 北京玖恩启明电子科技有限公司

X: ±0.30	APPD: Mr.Wu	TITLE:
X: ±0.20	CHKD: Mr.Wu	29PIN 焊板式 母头+后铁壳
.XXX±0.05	Dr: Gus chong	PART NO: JIONS-0031
X: ±1"	UNITS: mm	DWG NO: WWW.JIONS.COM.CN
	SCALE: 1:1	SHEET: 10/1